

1.本站收集的数据手册和产品资料都来自互联网,版权归原作者所有。如读者和版权方有任 何异议请及时告之,我们将妥善解决。

本站提供的中文数据手册是英文数据手册的中文翻译,其目的是协助用户阅读,该译文无法自动跟随原稿更新,同时也可能存在翻译上的不当。建议读者以英文原稿为参考以便获得更精准的信息。

3.本站提供的产品资料,来自厂商的技术支持或者使用者的心得体会等,其内容可能存在描 叙上的差异,建议读者做出适当判断。

4.如需与我们联系,请发邮件到marketing@iczoom.com,主题请标有"数据手册"字样。

Read Statement

1. The datasheets and other product information on the site are all from network reference or other public materials, and the copyright belongs to the original author and original published source. If readers and copyright owners have any objections, please contact us and we will deal with it in a timely manner.

2. The Chinese datasheets provided on the website is a Chinese translation of the English datasheets. Its purpose is for reader's learning exchange only and do not involve commercial purposes. The translation cannot be automatically updated with the original manuscript, and there may also be improper translations. Readers are advised to use the English manuscript as a reference for more accurate information.

3. All product information provided on the website refer to solutions from manufacturers' technical support or users the contents may have differences in description, and readers are advised to take the original article as the standard.

4. If you have any questions, please contact us at marketing@iczoom.com and mark the subject with "Datasheets".



VNP49N04

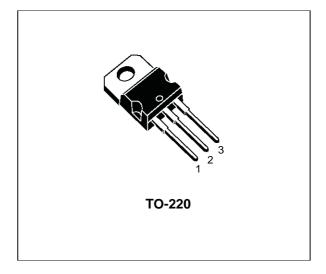
OMNIFET : FULLY AUTOPROTECTED POWER MOSFET

| TYPE | V _{clamp} | R _{DS(on)} | l _{lim} |
|----------|--------------------|---------------------|------------------|
| VNP49N04 | 42 V | 0.02 Ω | 49 A |

- LINEAR CURRENT LIMITATION
- THERMAL SHUT DOWN
- SHORT CIRCUIT PROTECTION
- INTEGRATED CLAMP
- LOW CURRENT DRAWN FROM INPUT PIN
- DIAGNOSTIC FEEDBACK THROUGH INPUT PIN
- ESD PROTECTION
- DIRECT ACCESS TO THE GATE OF THE POWER MOSFET (ANALOG DRIVING)
- COMPATIBLE WITH STANDARD POWER MOSFET
- STANDARD TO-220 PACKAGE

DESCRIPTION

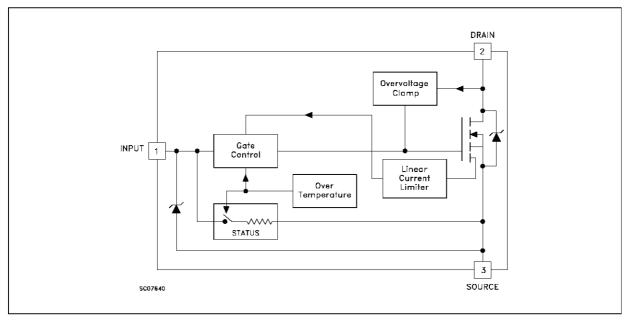
The VNP49N04 is a monolithic device made using STMicroelectronics VIPower Technology, intended for replacement of standard power MOSFETS in DC to 50 KHz applications. Built-in thermal shut-down, linear current limita-



tion and overvoltage clamp protect the chip in harsh enviroments.

Fault feedback can be detected by monitoring the voltage at the input pin.

BLOCK DIAGRAM



ABSOLUTE MAXIMUM RATING

| Symbol | Parameter | Value | Unit |
|---|---|--------------------|------|
| V _{DS} | Drain-source Voltage (V _{in} = 0) | Internally Clamped | V |
| Vin | Input Voltage | 18 | V |
| ID | Drain Current | Internally Limited | Α |
| I _R | Reverse DC Output Current | -50 | Α |
| V_{esd} | Electrostatic Discharge (C= 100 pF, R=1.5 KΩ) | 2000 | V |
| P _{tot} | Total Dissipation at $T_c = 25 \ ^{\circ}C$ | 125 | W |
| T _j Operating Junction Temperature | | Internally Limited | °C |
| Tc | Case Operating Temperature | Internally Limited | °C |
| T _{stg} Storage Temperature | | -55 to 150 | °C |

THERMAL DATA

| R _{thj-case} | Thermal | Resistance | Junction-case | Max | 1 | °C/W |
|-----------------------|---------|------------|------------------|-----|------|------|
| R _{thj-amb} | Thermal | Resistance | Junction-ambient | Max | 62.5 | °C/W |

ELECTRICAL CHARACTERISTICS ($T_{case} = 25 \,^{\circ}C$ unless otherwise specified) OFF

| Symbol | Parameter | Test Conditions | Min. | Тур. | Max. | Unit |
|-------------------|---|-------------------------------------|------|------|-----------|----------|
| VCLAMP | Drain-source Clamp Voltage | $I_D = 200 \text{ mA}$ $V_{in} = 0$ | 36 | 42 | 48 | V |
| V _{CLTH} | Drain-source Clamp Threshold Voltage | $I_D = 2 \text{ mA} V_{in} = 0$ | 35 | | | V |
| VINCL | Input-Source Reverse Clamp Voltage | I _{in} = -1 mA | -1 | | -0.3 | V |
| I _{DSS} | Zero Input Voltage Drain Current (V _{in} = 0) | | | | 50 200 | μΑ μΑ |
| l _{ISS} | Supply Current from Input Pin | $V_{DS} = 0 V V_{in} = 10 V$ | | 250 | 500 | μA |

ON (*)

| Symbol | Parameter | Test Conditions | Min. | Тур. | Max. | Unit |
|---------------------|--------------------------------------|---|------|------|---------------|--------|
| V _{IN(th)} | Input Threshold Voltage | $V_{DS} = V_{in}$ $I_D + I_{in} = 1 \text{ mA}$ | 0.8 | | 3 | V |
| R _{DS(on)} | Static Drain-source On Resistance | | | | 0.02 0.025 | Ω Ω |

DYNAMIC

| Symbol | Parameter | Test Conditions | Min. | Тур. | Max. | Unit |
|---------------------|-----------------------------|--|------|------|------|------|
| g _{fs} (*) | Forward Transconductance | $V_{DS} = 13 V$ $I_{D} = 25 A$ | 25 | 30 | | S |
| Coss | Output Capacitance | $V_{DS} = 13 V$ f = 1 MHz $V_{in} = 0$ | | 1100 | 1500 | рF |

57

ELECTRICAL CHARACTERISTICS (continued)

SWITCHING (**)

| Symbol | Parameter | Test Conditions | Min. | Тур. | Max. | Unit |
|---|---|---|------|---------------------------|----------------------------|----------------------|
| t _{d(on)} t _r t _{d(off)} t _f | Turn-on Delay Time Rise Time Turn-off Delay Time Fall Time | | | 200 1300 800 300 | 300 1800 1200 450 | ns ns ns ns |
| t _{d(on)} t _r t _{d(off)} t _f | Turn-on Delay Time Rise Time Turn-off Delay Time Fall Time | | | 1.3 3.8 12 6.1 | 1.9 5.2 14 8.5 | μs μs μs μs |
| (di/dt) _{on} | Turn-on Current Slope | V_{DD} = 15 V I _D = 25 A V _{in} = 10 V R _{gen} = 10 Ω | | 25 | | A/µs |
| Qi | Total Input Charge | $V_{DD} = 15 \text{ V}$ $I_D = 25 \text{ A}$ $V_{in} = 10 \text{ V}$ | | 100 | | nC |

SOURCE DRAIN DIODE

| Symbol | Parameter | Test Conditions | Min. | Тур. | Max. | Unit |
|-----------------------|-----------------------------|--|------|------|------|------|
| Vsd (*) | Forward On Voltage | IsD = 25 A Vin = 0 | | | 1.6 | V |
| t _{rr} (**) | Reverse Recovery Time | $I_{SD} = 25 \text{ A}$ di/dt = 100 A/µs V _{DD} = 30 V $T_i = 25 ^{\circ}\text{C}$ | | 250 | | ns |
| Qrr (**) | Reverse Recovery Charge | (see test circuit, figure 5) | | 910 | | nC |
| I _{RRM} (**) | Reverse Recovery Current | | | 7.5 | | A |

PROTECTION

| Symbol | Parameter | Test Conditions | Min. | Тур. | Max. | Unit |
|------------------------|----------------------------------|---|----------|----------|-----------|----------|
| l _{lim} | Drain Current Limit | | 30 30 | 49 49 | 68 68 | A A |
| t _{dlim} (**) | Step Response Current Limit | V _{in} = 10 V V _{in} = 5 V | | 35 90 | 50 150 | μs μs |
| T _{jsh} (**) | Overtemperature Shutdown | | 150 | | | °C |
| T _{jrs} (**) | Overtemperature Reset | | 135 | | | °C |
| l _{gf} (**) | Fault Sink Current | | | 50 20 | | mA mA |
| E _{as} (**) | Single Pulse Avalanche Energy | starting T _j = 25 $^{\circ}$ C V _{DD} = 20 V V _{in} = 10 V R _{gen} = 1 K Ω L = 6 mH | 4 | | | J |

(*) Pulsed: Pulse duration = 300 $\mu s,$ duty cycle 1.5 % (**) Parameters guaranteed by design/characterization

57

PROTECTION FEATURES

During normal operation, the Input pin is electrically connected to the gate of the internal power MOSFET. The device then behaves like a standard power MOSFET and can be used as a switch from DC to 50 KHz. The only difference from the user s standpoint is that a small DC current (I_{iss}) flows into the Input pin in order to supply the internal circuitry.

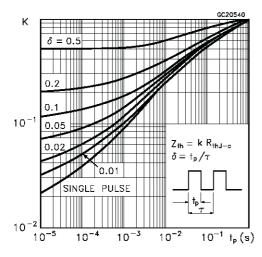
The device integrates:

- OVERVOLTAGE CLAMP PROTECTION: internally set at 42V, along with the rugged avalanche characteristics of the Power MOSFET stage give this device unrivalled ruggedness and energy handling capability. This feature is mainly important when driving inductive loads.
- LINEAR CURRENT LIMITER CIRCUIT: limits the drain current Id to Ilim whatever the Input pin voltage. When the current limiter is active, the device operates in the linear region, so power dissipation may exceed the capability of the heatsink. Both case and junction temperatures increase, and if this phase lasts long enough, junction temperature may reach the overtemperature threshold T_{jsh}.
- OVERTEMPERATURE AND SHORT CIRCUIT PROTECTION: these are based on sensing the chip temperature and are not dependent on the input voltage. The location of the sensing element on the chip in the power stage area ensures fast, accurate detection of the junction temperature. Overtemperature cutout occurs at minimum 150°C. The device is automatically restarted when the chip temperature falls below 135°C.
- STATUS FEEDBACK: In the case of an overtemperature fault condition, a Status Feedback is provided through the Input pin. The internal protection circuit disconnects the input from the gate and connects it instead to ground via an equivalent resistance of 100 Ω . The failure can be detected by monitoring the voltage at the Input pin, which will be close to ground potential.

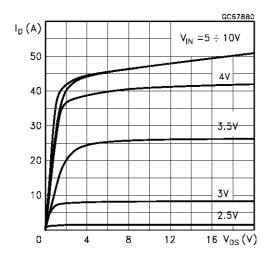
Additional features of this device are ESD protection according to the Human Body model and the ability to be driven from a TTL Logic circuit (with a small increase in R_{DS(on)}).

57

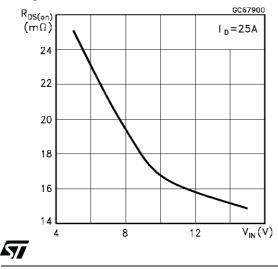
Thermal Impedance



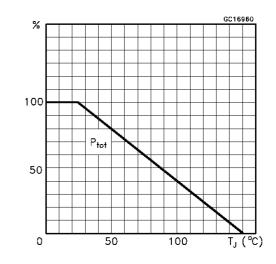
Output Characteristics



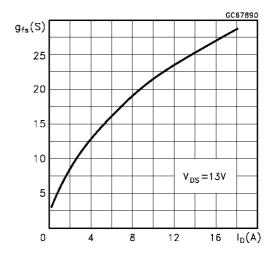
Static Drain-Source On Resistance vs Input Voltage



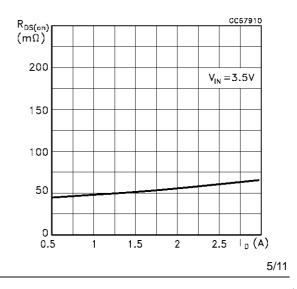
Derating Curve

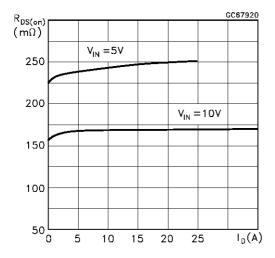


Transconductance



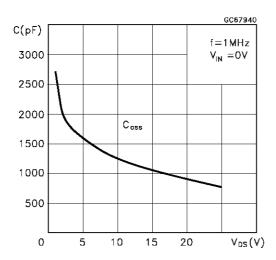
Static Drain-Source On Resistance



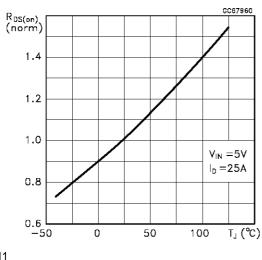


Static Drain-Source On Resistance

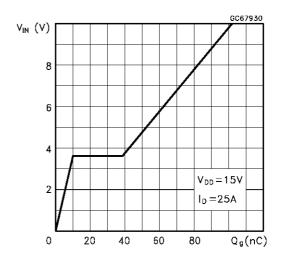
Capacitance Variations



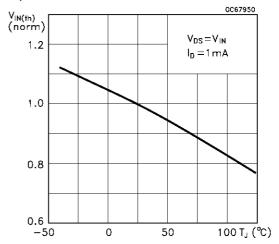
Normalized On Resistance vs Temperature



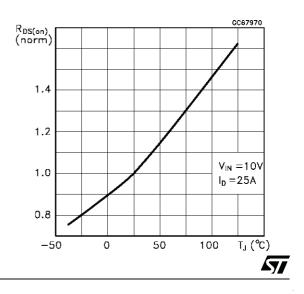
Input Charge vs Input Voltage



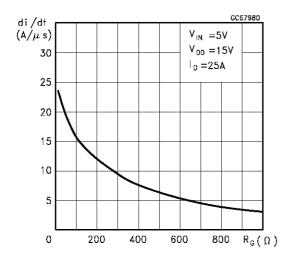
Normalized Input Threshold Voltage vs Temperature



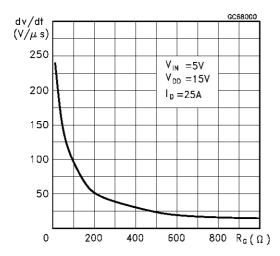
Normalized On Resistance vs Temperature



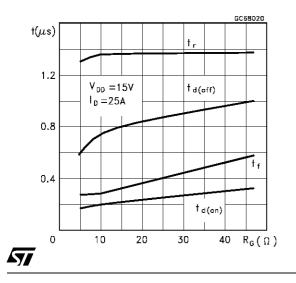
Turn-on Current Slope



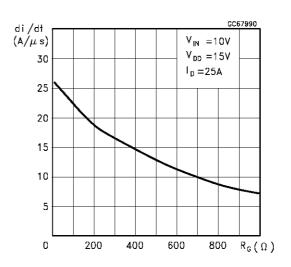
Turn-off Drain-Source Voltage Slope

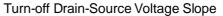


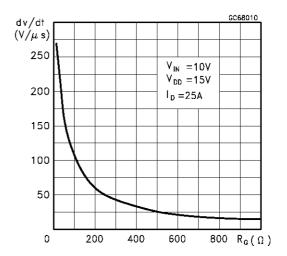
Switching Time Resistive Load



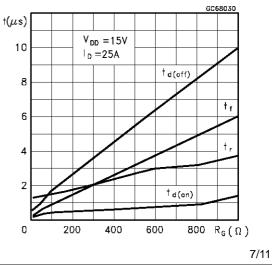
Turn-on Current Slope



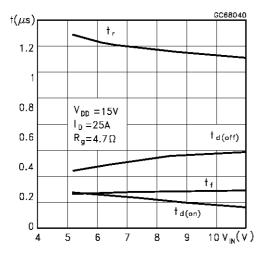




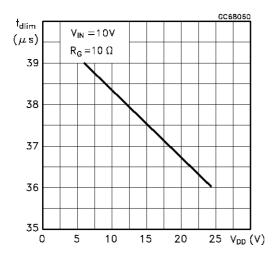




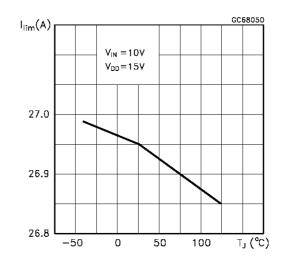
Switching Time Resistive Load



Step Response Current Limit



Current Limit vs Junction Temperature



Source Drain Diode Forward Characteristics

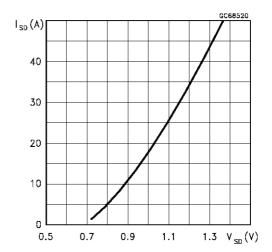




Fig. 1: Unclamped Inductive Load Test Circuits

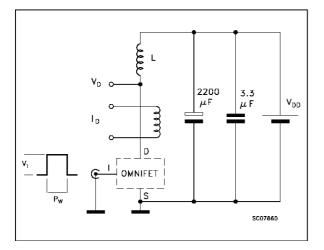


Fig. 3: Switching Times Test Circuits For Resistive Load

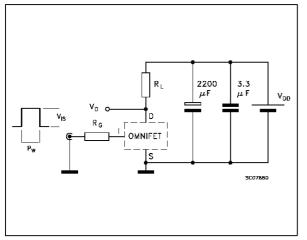


Fig. 5: Test Circuit For Inductive Load Switching And Diode Recovery Times

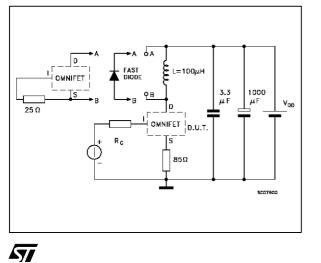


Fig. 2: Unclamped Inductive Waveforms

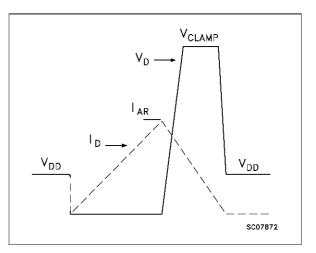


Fig. 4: Input Charge Test Circuit

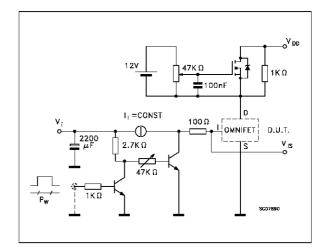
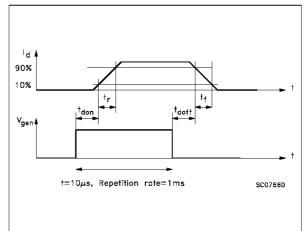


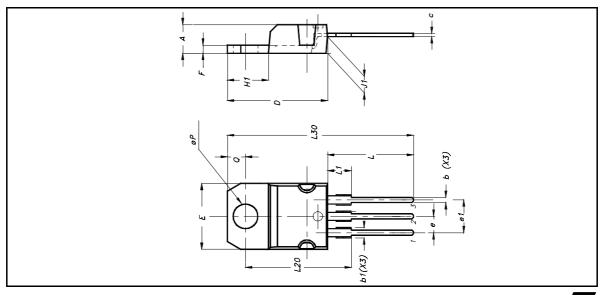
Fig. 6: Waveforms



VNP49N04

TO-220 MECHANICAL DATA

| DIM | mm. | | | | |
|----------------|-------|---------------|-------|--|--|
| DIM. | MIN. | ТҮР | MAX. | | |
| A | 4.40 | | 4.60 | | |
| b | 0.61 | | 0.88 | | |
| b1 | 1.15 | | 1.70 | | |
| с | 0.49 | | 0.70 | | |
| D | 15.25 | | 15.75 | | |
| E | 10 | | 10.40 | | |
| е | 2.40 | | 2.70 | | |
| e1 | 4.95 | | 5.15 | | |
| F | 1.23 | | 1.32 | | |
| H1 | 6.20 | | 6.60 | | |
| J1 | 2.40 | | 2.72 | | |
| L | 13 | | 14 | | |
| L1 | 3.50 | | 3.93 | | |
| L20 | | 16.40 | | | |
| L30 | | 28.90 | | | |
| ØP | 3.75 | | 3.85 | | |
| Q | 2.65 | | 2.95 | | |
| Package Weight | | 1.9Gr. (Typ.) | | | |



Information furnished is believed to be accurate and reliable. However, STMicroelectronics assumes no responsibility for the consequences of use of such information nor for any infringement of patents or other rights of third parties which may results from its use. No license is granted by implication or otherwise under any patent or patent rights of STMicroelectronics. Specifications mentioned in this publication are subject to change without notice. This publication supersedes and replaces all information previously supplied. STMicroelectronics products are not authorized for use as critical components in life support devices or systems without express written approval of STMicroelectronics. The ST logo is a trademark of STMicroelectronics

© 2004 STMicroelectronics - Printed in ITALY- All Rights Reserved.

STMicroelectronics GROUP OF COMPANIES

Australia - Brazil - Canada - China - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia -Malta - Morocco - Singapore - Spain - Sweden - Switzerland - United Kingdom - U.S.A.

http://www.st.com

57